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Address: Acta Technica

Institute of Thermomechanics CAS, v.v.i.

Dolejškova 5

18200 Praha 8, Czech Republic

E-mail: journal@it.cas.cz Phone: +420 266052058 Fax: +420 286890433

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Subscription Information

Address: Ivo Doležel

Kolínská 19/1666 $130\,00$ Praha 3

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